

50V N-Channel Enhancement Mode MOSFET – ESD Protected

Voltage 50 V Current 350 mA

Features

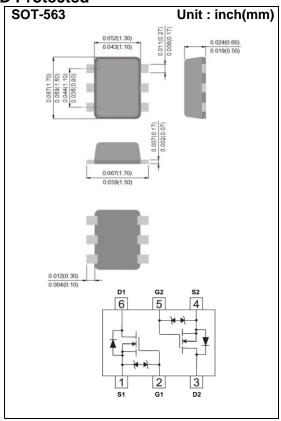
- RDS(ON), VGS@10V, ID@500mA<1.6Ω
- RDS(ON), VGS@4.5V, ID@200mA<2.5Ω
- RDS(ON), VGS@2.5V, ID@100mA<4.5Ω
- Advanced Trench Process Technology
- Specially Designed for Battery Operated Systems, Solid-State Relays Drivers: Relay, Displays, Memories, etc.
- ESD Protected 2KV HBM
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

Mechanical Data

• Case: SOT-563 Package

• Terminals : Solderable per MIL-STD-750, Method 2026

Approx. Weight: 0.0026 grams



Maximum Ratings and Thermal Characteristics (T_A=25°C unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNITS
Drain-Source Voltage		V _{DS}	50	V
Gate-Source Voltage		V _G s	<u>+</u> 20	V
Continuous Drain Current		I _D	350	mA
Pulsed Drain Current		I _{DM}	1200	mA
Power Dissipation	T _A =25°C	P _D	223	mW
	Derate above 25°C		1.8	mW/°C
Operating Junction and Storage Temperature Range		T _J ,T _{STG}	-55~150	°C
Typical Thermal Resistance				
- Junction to Ambient ^(Note 3)		RөJA	560	°C/W



Electrical Characteristics (T_A=25°C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS	
Static							
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V,I _D =250uA	50	-	-	V	
Gate Threshold Voltage	$V_{GS(th)}$	V _{DS} =V _{GS} , I _D =250uA	0.8	1.0	1.5	V	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =10V,I _D =500mA	-	0.96	1.6	Ω	
		V _{GS} =4.5V,I _D =200mA	-	1.25	2.5		
		V _{GS} =2.5V,I _D =100mA	-	2.73	4.5		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =50V,V _{GS} =0V	-	0.01	1	uA	
Gate-Source Leakage Current	Igss	V _{GS} = <u>+</u> 20V,V _{DS} =0V	-	<u>+</u> 3.0	<u>+</u> 10	uA	
Dynamic							
Total Gate Charge	Q_g	\/ OF\/ OFO	-	0.63	1	nC	
Gate-Source Charge	Q_gs	V _{DS} =25V, I _D =250mA, V _{GS} =4.5V ^(Note 1,2)	-	0.2	-		
Gate-Drain Charge	Q_gd	VGS=4.5V(Note 1,2)	-	0.23	-		
Input Capacitance	Ciss	\\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	-	25	50	pF	
Output Capacitance	Coss	V _{DS} =25V, V _{GS} =0V,	-	9.5	20		
Reverse Transfer Capacitance	Crss	f=1.0MHZ	-	2.1	5		
Switching							
Turn-On Delay Time	td _(on))/ O5)/ L 500 A	-	2.2	5	ns	
Turn-On Rise Time	tr	V _{DD} =25V, I _D =500mA,	-	19.2	38		
Turn-Off Delay Time	td _(off)	V _{GS} =10V,	-	6.2	12		
Turn-Off Fall Time	tf	$R_G=6\Omega^{(Note\ 1,2)}$	-	23	50		
Drain-Source Diode							
Maximum Continuous Drain-Source Diode Forward Current	Is		-	-	500	mA	
Diode Forward Voltage	V _{SD}	Is=500mA, V _{GS} =0V	-	0.86	1.5	V	

NOTES:

- 1. Pulse width<a>300us, Duty cycle<a>2%
- 2. Essentially independent of operating temperature typical characteristics.
- 3. Rejula is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. mounted on a 1 inch square pad of copper



TYPICAL CHARACTERISTIC CURVES

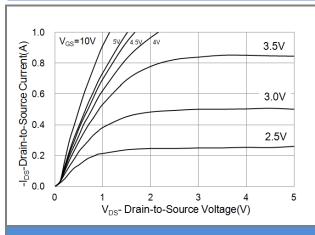


Fig.1 On-Region Characteristics

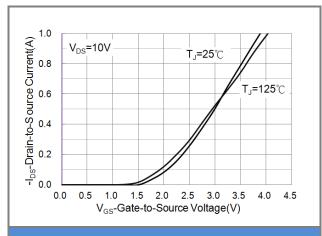


Fig.2 Transfer Characteristics

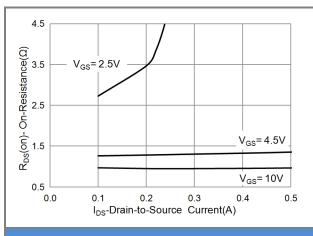


Fig.3 On-Resistance vs. Drain Current

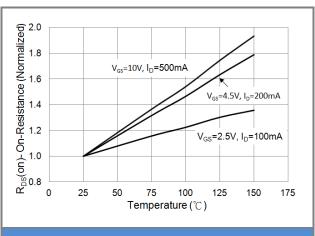


Fig.4 On-Resistance vs. Junction temperature

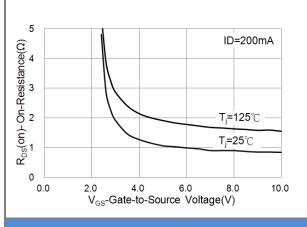


Fig.5 On-Resistance Variation with VGS.

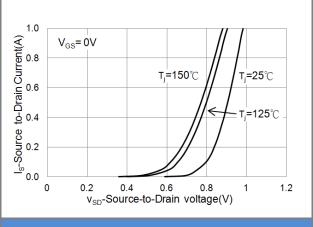


Fig.6 Body Dlode CharacterIslcs



TYPICAL CHARACTERISTIC CURVES

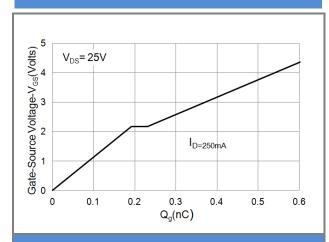


Fig.7 Gate-Charge Characteristics

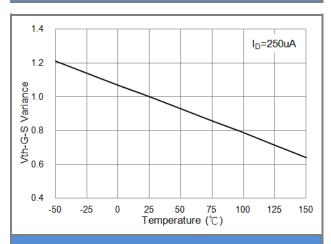


Fig.9 Threshold Voltage Variation with Temperature.

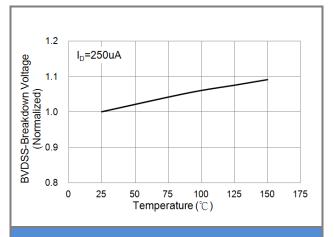


Fig.8 Breakdown Voltage Variation vs. Temperature

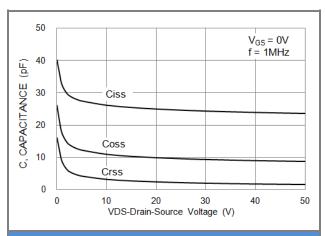


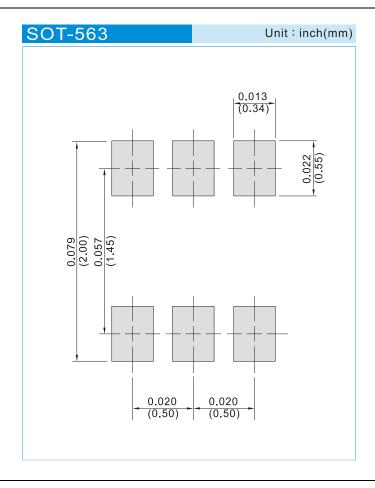
Fig.10 Capacitance vs. Drain-Source Voltage.



Product and Packing Information

Part No.	Package Type	Packing Type	Marking	
PJX138K	SOT-563	4K pcs / 7" reel	8KB	
PJX138K	SOT-563	10K pcs / 13" reel	8KB	
PJX138K	SOT-563	8K pcs / 7" reel	8KB	
PJX138K	SOT-563	20K pcs / 13" reel	8KB	

Mounting Pad Layout





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